

"#0-65&96.3"5*/(4

SUPPLY VOLTAGE, +V _S to -V _S	300V
OUTPUT CURRENT, within SOA	2.0A
POWER DISSIPATION, internal at T _C = 25°C ¹	83W
INPUT VOLTAGE, referred to COM	±15V
TEMPERATURE, pin solder—10 sec max	300°C
TEMPERATURE, junction ¹	175°C
TEMPERATURE, storage	-65 to +150°C
OPERATING TEMPERATURE RANGE, case	-55 to +125°C

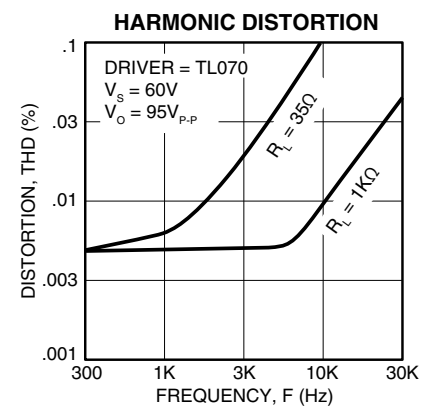
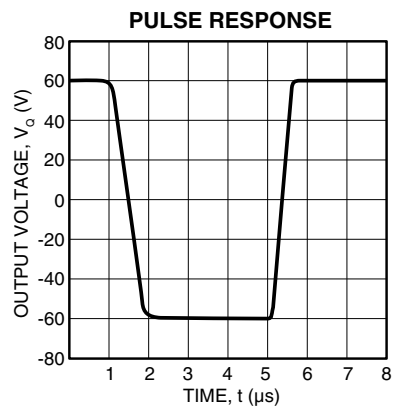
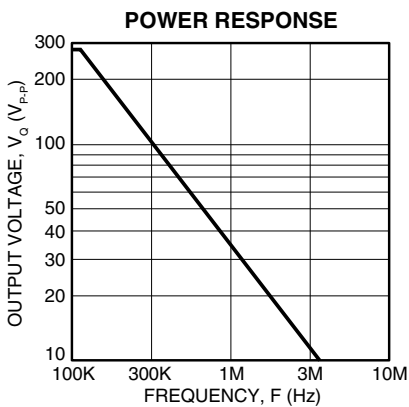
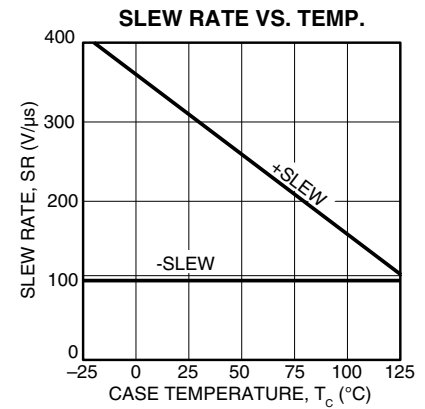
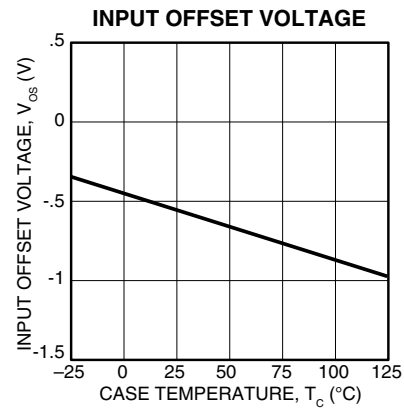
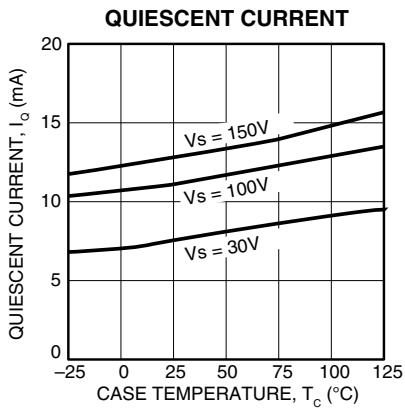
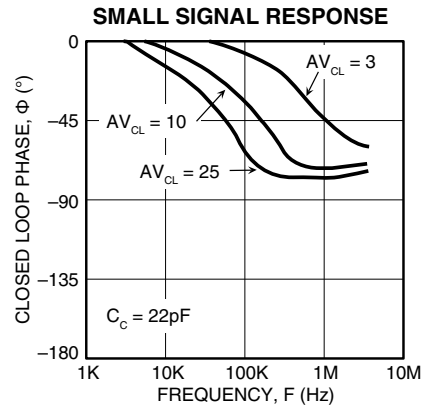
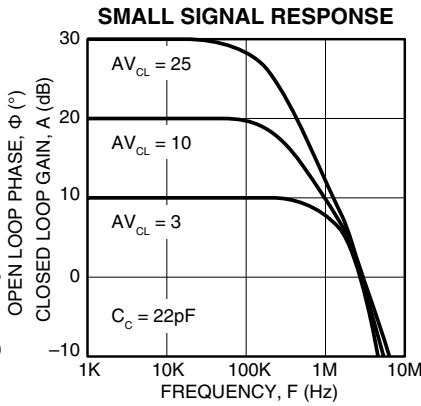
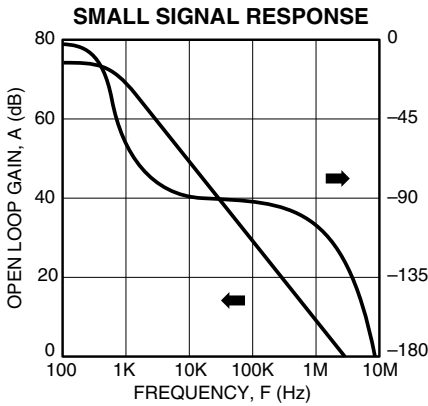
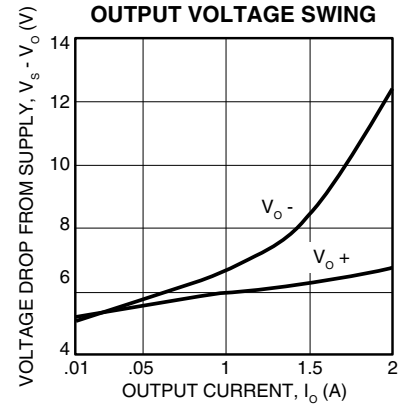
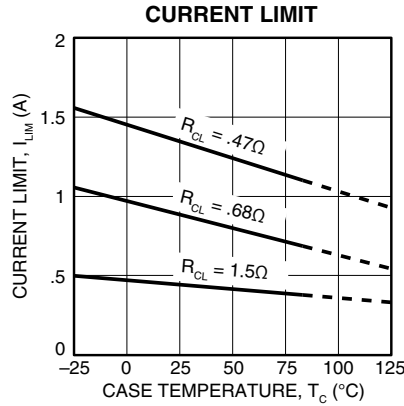
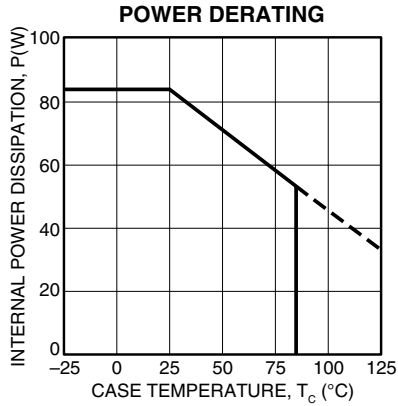
41&5*0/4

PARAMETER	TEST CONDITIONS ²	PB58			PB58A			UNITS
		MIN	TYP	MAX	MIN	TYP	MAX	
INPUT								
OFFSET VOLTAGE, initial			±.75	±1.75		*	±1.0	V
OFFSET VOLTAGE, vs. temperature	Full temperature range ³		-4.5	-7		*	*	mV/°C
INPUT IMPEDANCE, DC		25	50		*	*		k
INPUT CAPACITANCE			3			*		pF
CLOSED LOOP GAIN RANGE		3	10	25	*	*	*	V/V
GAIN ACCURACY, internal R _g , R _f	A _v = 3		±10	±15		*	*	%
GAIN ACCURACY, external R _f	A _v = 10		±15	±25		*	*	%
PHASE SHIFT	f = 10kHz, A _{VCL} = 10, C _C = 22pF		10			*		°
	f = 200kHz, A _{VCL} = 10, C _C = 22pF		60			*		°
OUTPUT								
VOLTAGE SWING	I _o = 1.5A (PB58), 2A (PB58A)	V _S -11	V _S -8		V _S -15	V _S -11		V
VOLTAGE SWING	I _o = 1A	V _S -10	V _S -7		*	*		V
VOLTAGE SWING	I _o = .1A	V _S -8	V _S -5		*	*		V
CURRENT, continuous		1.5			2.0			A
SLEW RATE	Full temperature range	50	100		75	*		V/μs
CAPACITIVE LOAD	Full temperature range		2200			*		pF
SETTLING TIME to .1%	R _L = 100 Ω, 2V step		2			*		μs
POWER BANDWIDTH	V _C = 100 Vpp	160	320		240	*		kHz
SMALL SIGNAL BANDWIDTH	C _C = 22pF, A _v = 25, V _{CC} = ±100		100			*		kHz
SMALL SIGNAL BANDWIDTH	C _C = 22pF, A _v = 3, V _{CC} = ±30		1			*		MHz
POWER SUPPLY								
VOLTAGE, ±V _S ⁴	Full temperature range	±15 ⁶	±60	±150	*	*	*	V
CURRENT, quiescent	V _S = ±15		11			*		mA
	V _S = ±60		12			*		mA
	V _S = ±150		14	18		*	*	mA
THERMAL								
RESISTANCE, AC junction to case ⁵	Full temp. range, f > 60Hz		1.2	1.3		*	*	°C/W
RESISTANCE, DC junction to case	Full temp. range, f < 60Hz		1.6	1.8		*	*	°C/W
RESISTANCE, junction to air	Full temperature range		30			*	*	°C/W
TEMPERATURE RANGE, case	Meets full range specifications	-25	25	85	*	*	*	°C

- NOTES: * The specification of PB58A is identical to the specification for PB58 in applicable column to the left.
1. Long term operation at the maximum junction temperature will result in reduced product life. Derate internal power dissipation to achieve high MTTF (Mean Time to Failure).
 2. The power supply voltage specified under typical (TYP) applies, T_C = 25°C unless otherwise noted.
 3. Guaranteed by design but not tested.
 4. +V_S and -V_S denote the positive and negative supply rail respectively.
 5. Rating applies if the output current alternates between both output transistors at a rate faster than 60Hz.
 6. +V_S/-V_S must be at least 15V above/below COM.

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The PB58 is constructed from MOSFET transistors. ESD handling procedures must be observed. The internal substrate contains beryllia (BeO). Do not break the seal. If accidentally broken, do not crush, machine, or subject to temperatures in excess of 850°C to avoid generating toxic fumes.

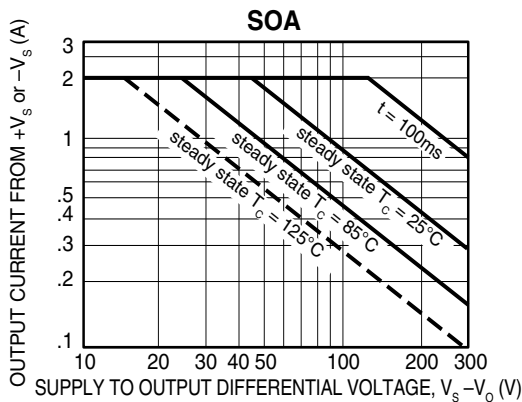


4-15

Please read Application Note 1 "General Operating Considerations" which covers stability, supplies, heat sinking, mounting, current limit, SOA interpretation, and specification interpretation. Visit www.Cirrus.com for design tools that help automate tasks such as calculations for stability, internal power dissipation, current limit; heat sink selection; Apex Precision Power's complete Application Notes library; Technical Seminar Workbook; and Evaluation Kits.

4-16

For proper operation, the current limit resistor (R_{CL}) must be connected as shown in the external connection diagram. The minimum value is 0.33 Ω with a maximum practical value of 47 Ω . For optimum reliability the resistor value should be set as high as possible. The value is calculated as follows: $I_L = .65/R_{CL} + .010$, $-I_L = .65/R_{CL}$.



4-17

NOTE: The output stage is protected against transient yback. However, for protection against sustained, high energy yback, external fast-recovery diodes should be used.

4-18

Cascading two amplifiers within a feedback loop has many advantages, but also requires careful consideration of several amplifier and system parameters. The most important of these are gain, stability, slew rate, and output swing of the driver. Operating the booster amplifier in higher gains results in a higher slew rate and lower output swing requirement for the driver, but makes stability more difficult to achieve.

4-19

$$R_G = [(A_v - 1) \cdot 3.1\text{K}] - 6.2\text{K}$$

$$A_v = \frac{R_G + 6.2\text{K}}{3.1\text{K}} + 1$$

The booster's closed-loop gain is given by the equation above. The composite amplifier's closed loop gain is determined by the feedback network, that is: $-R_f/R_i$ (inverting) or $1 + R_f/R_i$ (non-inverting). The driver amplifier's "effective gain" is equal to the composite gain divided by the booster gain.

Example: Inverting configuration (Figure 1) with $R_i = 2\text{K}$, $R_f = 60\text{K}$, $R_g = 0$:

A_v (booster) = $(6.2\text{K}/3.1\text{K}) + 1 = 3$
 A_v (composite) = $60\text{K}/2\text{K} = -30$
 A_v (driver) = $-30/3 = -10$

4-20

Stability can be maximized by observing the following guidelines:

1. Operate the booster in the lowest practical gain.
2. Operate the driver amplifier in the highest practical effective gain.
3. Keep gain-bandwidth product of the driver lower than the closed loop bandwidth of the booster.
4. Minimize phase shift within the loop.

A good compromise for (1) and (2) is to set booster gain from 3 to 10 with total (composite) gain at least a factor of 3 times booster gain. Guideline (3) implies compensating the driver as required in low composite gain configurations. Phase shift within the loop (4) is minimized through use of booster and loop compensation capacitors C_c and C_f when required. Typical values are 5pF to 33pF.

Stability is the most difficult to achieve in a configuration where driver effective gain is unity (ie; total gain = booster gain). For this situation, Table 1 gives compensation values for optimum square wave response with the op amp drivers listed.

DRIVER	C_{CH}	C_F	C_C	FPBW	SR
OP07	-	22p	22p	4kHz	1.5
741	-	18p	10p	20kHz	7
LF155	-	4.7p	10p	60kHz	>60
LF156	-	4.7p	10p	80kHz	>60
TL070	22p	15p	10p	80kHz	>60

For: $R_f = 33\text{K}$, $R_i = 3.3\text{K}$, $R_g = 22\text{K}$

Table 1: Typical values for case where op amp effective gain = 1.

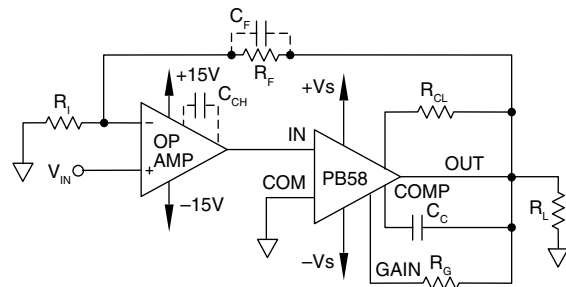


Figure 2. Non-inverting composite amplifier.

4-21

The slew rate of the composite amplifier is equal to the slew rate of the driver times the booster gain, with a maximum value equal to the booster slew rate.

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The maximum output voltage swing required from the driver op amp is equal to the maximum output swing from the booster divided by the booster gain. The V_{os} of the booster must also be supplied by the driver, and should be subtracted from the available swing range of the driver. Note also that effects of V_{os} drift and booster gain accuracy should be considered when calculating maximum available driver swing.

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For all Apex Precision Power product questions and inquiries, call toll free 800-546-2739 in North America.

For inquiries via email, please contact apex.support@cirrus.com.

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